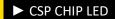
BRIGHTEK (EUROPE) LIMITED : Brighten up The World With CED !



PRODUCT DATASHEET



- ▶ 1818 0.92t Series
- Gold White (1800K - PC Amber)



1818 0.92t Series

ATTENTION

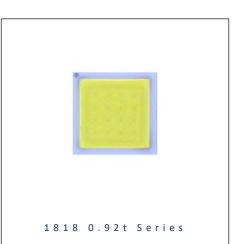
OBSERVEPRECAUTIO



AUTOMOTIVE

FEATURES:

- Package: Ceramic High Power CSP Package
- Forward Current: 700mA
- Forward Voltage (typ.): 3.0V
- Luminous Flux (typ.): 190lm@700mA
- **Colour:** Gold White (PC Amber)
- CCT/Colour Temperature (typ.): 1750~1900K
- Viewing angle: 115°
- Materials:
 - Die: Flip-Chip InGaN
 - Resin: Silicon (Yellow Diffused)
 - L/T Finish: Ag plated
- Operating Temperature: -40~+125°C
- Storage Temperature: -40~+125°C
- Grouping parameters:
 - Forward Voltage
 - Luminous Flux
 - CIE Chromaticity
- Soldering methods: IR Reflow
- Preconditioning: MSL2 according to J-STD020
- Packing: 8mm tape with max.2000pcs /reel, ø180mm (7")



NOW53S41PC

APPLICATIONS:

- Decorative Lighting
- Portable Lighting
- Outdoor Lighting
- Commercial Lighting
- Indoor Lighting
- Industrial Lighting

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CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
DC Forward Current	lf	1000	mA
Pulse Forward Current 1/10 Duty @ 1KHz	Ipf	1500	mA
Power Dissipation	PD	3.4	W
Reverse Voltage	V _R	5	V
Junction Temperature	Tj	150	°C
Thermal Resistance Junction to Solder Point	R _{th(J-S)}	10	°C/W
Temperature Coefficient of Voltage		-2.5	mV/°C
Operating Temperature	Topr	-40~+125	°C
Storage Temperature	T _{STG}	-40~+125	°C
Colour Rendering Index / Ra	CRI	65	

Electrical & Optical Characteristics (Ta=25°C)

Parameter	Symbol	Values			Unit	Test	
Parameter	Symbol	Min.	Тур.	Max.	Onit	Condition	
Forward Voltage	V _F	2.8	3.0	3.4	V	I _F =700mA	
Luminous Flux	Φv	170	190	210	lm	I⊧=700mA	
Chromaticity	х	0.5285		0.5682		I⊧=700mA	
Coordinates	Y	0.3935		0.4328			
ССТ		1750		1900	к	I⊧=700mA	
Viewing Angle	2 θ 1/2		115		deg	I⊧=700mA	

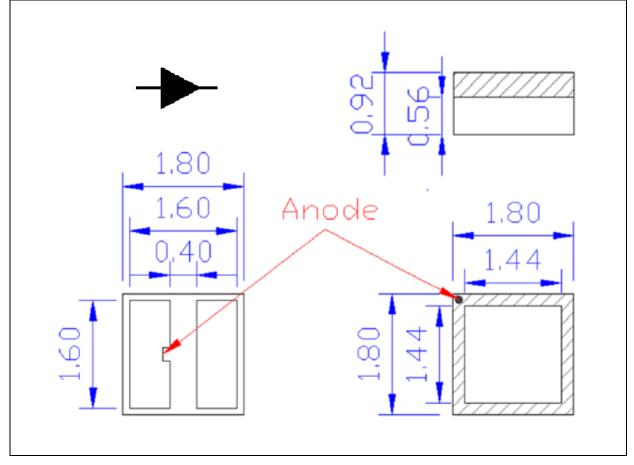
1. Luminous flux (Φ_V) ±7%, Forward Voltage (V_F) ±0.05V, Viewing angle(2 $\theta_{1/2}$) ±10°, CRI ±2

2

OUTLINE DIMENSION:

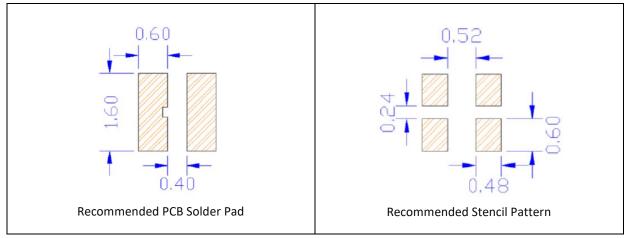


Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.13mm, unless otherwise noted.

Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ± 0.12 mm with angle tolerance $\pm 0.5^{\circ}$.



BINNING GROUPS:

Forward Voltage Classifications (I_F = 700mA):

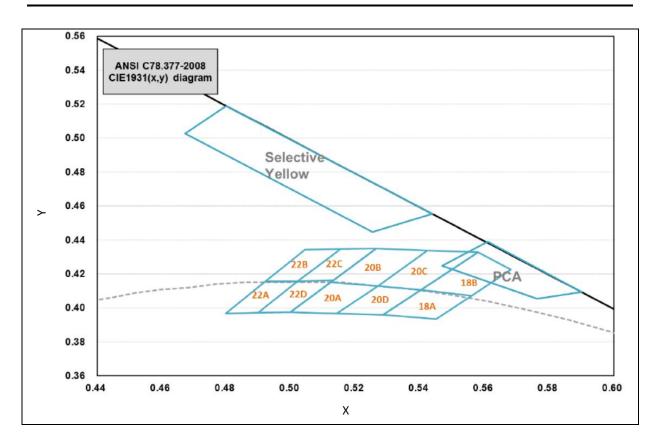
Code	Min.	Max.	Unit
M9	2.8	3.0	
MA	3.0	3.2	V
MB	3.2	3.4	

Luminous Flux Classifications (I_F = 700mA):

Code	Min.	Max.	Unit	
E09	170	190	las	
E10	190	210	lm	



CIE CHROMATICITY DIAGRAM:

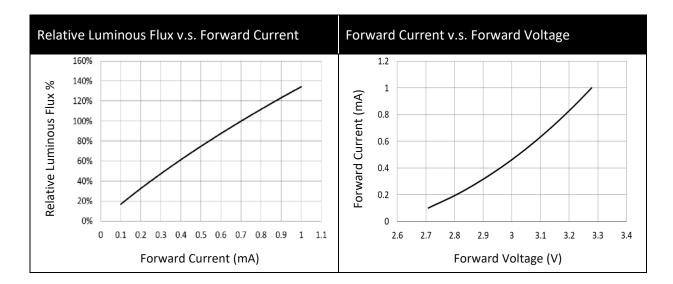


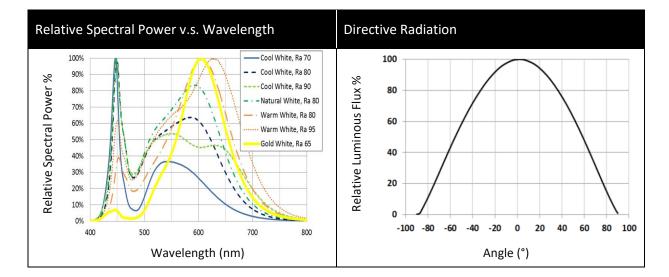
Chromaticity Coordinates Classifications (I_F = 700mA):

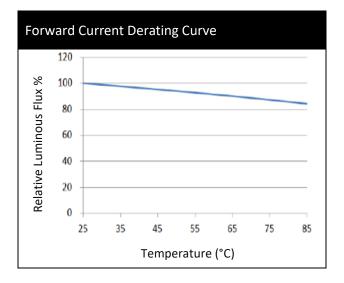
	1		1 2		3		4	
	Х	Y	Х	Y	Х	Y	Х	Y
18A	0.5285	0.3959	0.5403	0.4107	0.5560	0.4073	0.5450	0.3935
18B	0.5403	0.4107	0.5580	0.4328	0.5682	0.4225	0.5560	0.4073



ELECTRO-OPTICAL CHARACTERISTICS:

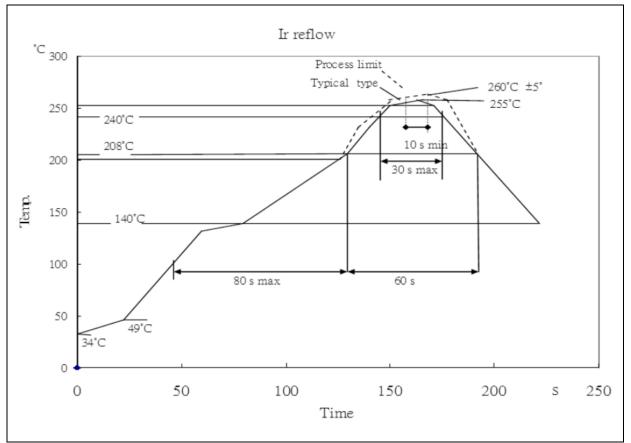








RECOMMENDED SOLDERING PROFILE:



Reflow Lead-free Solder:

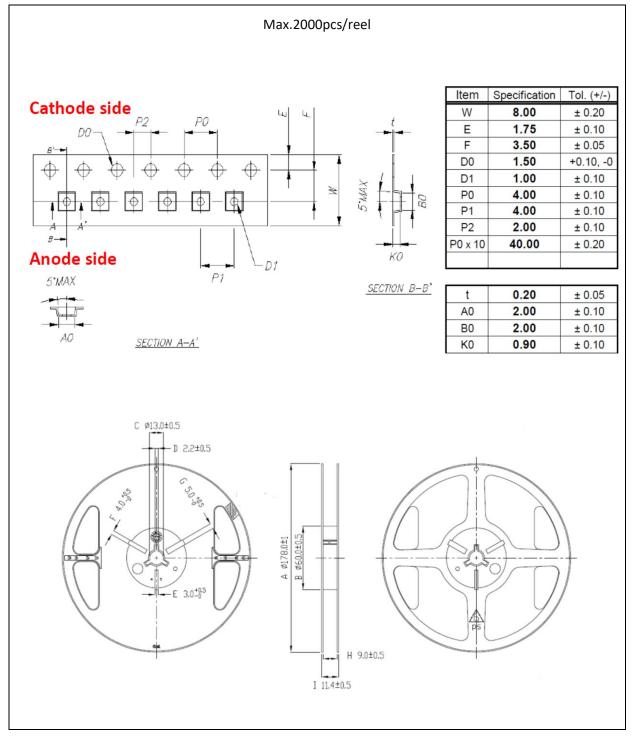
Note:

- 1. Maxima reflow soldering: 1 time.
- 2. The recommended reflow temperature is 240°C. The maximum soldering temperature should be limited to 260°C.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.



PACKING SPECIFICATION:

Reel Dimension:



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PRECAUTIONS OF USE:



Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking before use.

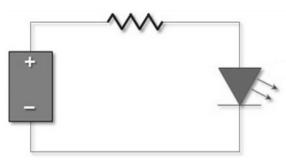
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±3°C x 24hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision
A1.0	22/03/2021	Datasheet set-up.
A1.1	23/10/2021	New datasheet format.